TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type (Four Darlington Power Transistors inOne)

MP4502

High Power Switching Applications Hammer Drive, Pulse Motor Drive and Inductive Load Switching

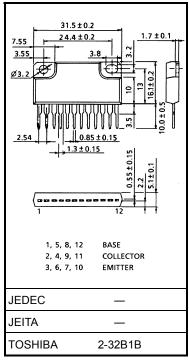
- Package with heat sink isolated to lead (SIP 12 pins)
- High collector power dissipation (4-device operation) : PT = 5 W (Ta = 25°C)
- High collector current: $I_{C(DC)} = 3 A \text{ (max)}$
- High DC current gain: $h_{FE} = 2000$ (min) ($V_{CE} = 2$ V, $I_{C} = 1.5$ A)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Collector-base voltage		V_{CBO}	120	V	
Collector-emitter voltage		V _{CEO}	100	V	
Emitter-base voltage		V _{EBO}	6	V	
Collector current	DC	I _C	3	Α	
Collector current	Pulse	I _{CP}	6	_ A	
Continuous base current		Ι _Β	0.5	Α	
Collector power dissipation (1-device operation)		P _C	3.0	W	
Collector power dissipation	Ta = 25°C	5.0 PT		w	
(4-device operation)	Tc = 25°C	PT	25	vv	
Isolation voltage		V _{Isol}	1000	V	
Junction temperature		Тј	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

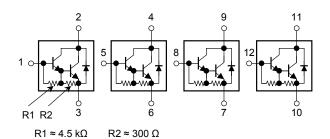
Industrial Applications

Unit: mm



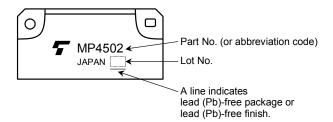
Weight: 6.0 g (typ.)

Array Configuration



2004-07-01

Marking



Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance from channel to ambient	sistance from channel to ΣR _{th (j-a)}		°C/W	
(4-device operation, Ta = 25°C)	()/			
Thermal resistance from channel to case	ΣR _{th (j-c)}	5.0	°C/W	
(4-device operation, Tc = 25°C)	,			
Maximum lead temperature for soldering purposes	TL	260	°C	
(3.2 mm from case for 10 s)	_			

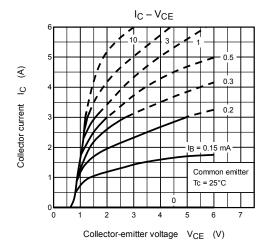
Electrical Characteristics (Ta = 25°C)

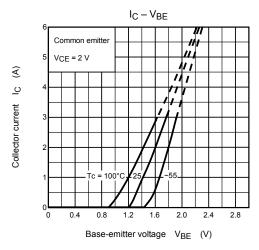
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cu	rrent	I _{CBO}	V _{CB} = 120 V, I _E = 0 A	_	_	10	μA
Collector cut-off cu	rrent	I _{CEO}	V _{CE} = 100 V, I _B = 0 A	_	_	10	μA
Emitter cut-off curr	ent	I _{EBO}	V _{EB} = 6 V, I _C = 0 A	0.5	_	2.5	mA
Collector-base brea	akdown voltage	V (BR) CBO	I _C = 1 mA, I _E = 0 A	120	_	_	V
Collector-emitter bi	reakdown voltage	V (BR) CEO	I _C = 10 mA, I _B = 0 A	100	_	_	V
DC current gain		h _{FE (1)}	V _{CE} = 2 V, I _C = 1.5 A	2000	_	15000	
		h _{FE (2)}	V _{CE} = 2 V, I _C = 3 A	1000	_	_	_
Saturation voltage	Collector-emitter	V _{CE (sat)}	I _C = 1.5 A, I _B = 3 mA	_	_	1.5	V
	Base-emitter	V _{BE (sat)}	I _C = 1.5 A, I _B = 3 mA	_	_	2.0	
Transition frequency		f _T	V _{CE} = 2 V, I _C = 0.5 A	_	60	_	MHz
Collector output capacitance		C _{ob}	V _{CB} = 10 V, I _E = 0 A, f = 1 MHz	_	30	_	pF
Switching time Storage time Fall time	ton	Output	_	0.3	_		
	Storage time	t _{stg}	20 μs I _{B2} V _{CC} = 30 V	_	2.0	_	μs
	Fall time	t _f	I _{B1} = -I _{B2} = 3 mA, duty cycle ≤ 1%	_	0.4	_	

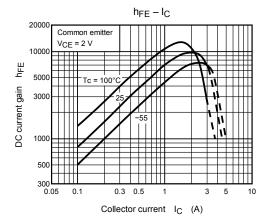
Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

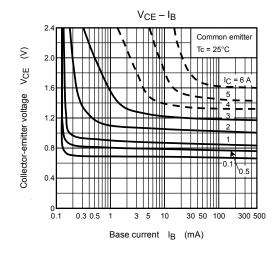
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward current	I _{FM}	_	_	_	3	Α
Surge current	I _{FSM}	t = 1 s, 1 shot	_	_	6	Α
Forward voltage	V _F	I _F = 1 A, I _B = 0 A	_	1.2	1.8	٧
Reverse recovery time	t _{rr}	I _F = 3 A, V _{BE} = -3 V, dI _F /dt = -50 A/μs	_	1.0	_	μs
Reverse recovery charge	Q _{rr}		_	5	_	μC

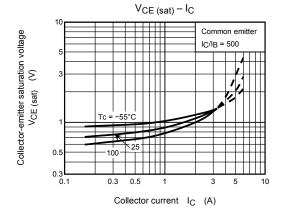
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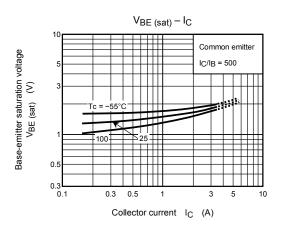


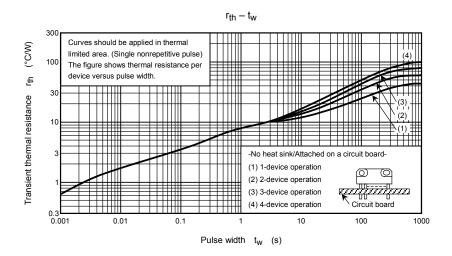


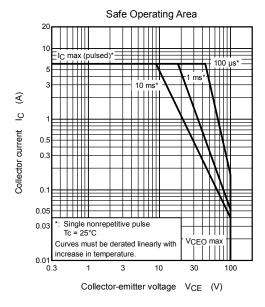


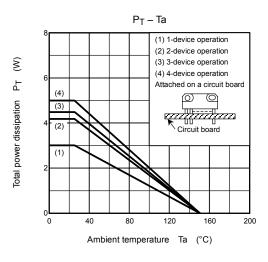


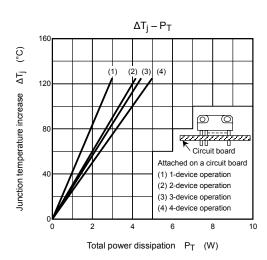












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Handbook" etc..

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